

SMFJ33A-T



Appearance & Shape



注意 NOTICE: All Specifications are subject to change without notice.

Page 1/3

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2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Specification

L size(mm)	3.85
W size(mm)	1.9
T size(mm)	1.35
Size code(Inch (mm))	SOD123FL
Direction Bi/Uni	Uni Direction
Channel	1
VRWM (V) Max	33
VB(V) Typical	36.7
VB(V) Max	40.6
Ipp (A)	3.8
Ppp (W)	200

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Page 2/3

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Notices

Glass passivated chip junction

Reliable low cost construction utilizing molded plastic technique

Excellent clamping voltage capability

Fast response time

Packing

Packing Reel (Inch)	Carrier tape	Standard package quantity (KPCS)	Piece weight (gram)	MSL Level
7	Plastic type	3	0.0143	1

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Page 3/3

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